Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2013. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that TAIYO YUDEN CO., LTD. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN CO., LTD. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact TAIYO YUDEN CO., LTD. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").
 - It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that TAIYO YUDEN CO., LTD. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. TAIYO YUDEN CO., LTD. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

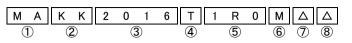
METAL CORE WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ MA SERIES)



REFLOW

■PARTS NUMBER

*Operating Temp. : -40~+105°C (Including self-generated heat)



①Series name

Code	Series name
MA	Metal Core Wire-wound Chip Power Inductors

②Dimensions (T)

Code	Dimensions (T) [mm]
KK	1.0
MK	1.2

③Dimensions (L×W)

Code	Dimensions (L × W) [mm]
2016	2.0 × 1.6
2520	2.5 × 2.0

4)Packaging

O	
Code	Packaging
T	Taping

⑤Nominal inductance

△=Blank space

	Code (example)	Nominal inductance [μ H]
	R47	0.47
	1R0	1.0
	4R7	4.7

※R=Decimal point

6 Inductance tolerance

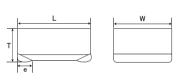
Code	Inductance tolerance
М	±20%

(7)Special code

Code	Special code
Δ	Standard

8 Internal code

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Туре	Type L		L W T		Standard quantity [pcs] Taping
MAKK2016	2.0 ± 0.1 (0.079 ± 0.004)	1.6±0.1 (0.063±0.004)	1.0 max (0.039 max)	0.5 ± 0.3 (0.020 \pm 0.012)	3000
MAKK2520	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.0 max (0.039 max)	0.5±0.3 (0.020±0.012)	3000
MAMK2520	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.2 max (0.047 max)	0.5±0.3 (0.020±0.012)	3000

Unit:mm(inch)

PARTS NUMBER

MAKK2016 type

Will did to type									
			Nominal inductance		Self-resonant	DC Resistance [Ω](max.)	Rated current ※) [mA](max.)		Measuring
	Parts number	EHS	[μ H]	Inductance tolerance	frequency [MHz] (min.)		Saturation current	Temperature rise current	frequency[MHz]
					[IVITZ] (MIN.)		Idc1	Idc2	
	MAKK2016TR24M	R₀HS	0.24	±20%	-	0.042	4,200	3,000	2
	MAKK2016TR47M	RoHS	0.47	±20%	-	0.460	3,200	2,800	2
	MAKK2016T1R0M	RoHS	1.0	±20%	-	0.075	2,200	2,200	2
	MAKK2016T1R5M	RoHS	1.5	±20%	-	0.130	1,600	1,650	2
	MAKK2016T2R2M	RoHS	2.2	±20%	-	0.160	1,500	1,500	2
	MAKK2016T3R3M	RoHS	3.3	±20%	-	0.255	1,150	1,200	2
	MAKK2016T4R7M	RoHS	4.7	±20%	-	0.380	1,000	950	2

MAKK2520 type

		Manada al Sada akana	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current ※) [mA](max.)		M
Parts number	EHS	Nominal inductance [μ H]				Saturation current Idc1	Temperature rise current Idc2	Measuring frequency[MHz]
MAKK2520T1R0M	RoHS	1.0	±20%	-	0.072	2,700	2,500	2
MAKK2520T2R2M	RoHS	2.2	±20%	-	0.156	1,900	1,500	2
MAKK2520T4R7M	RoHS	4.7	±20%	-	0.300	1,300	1,100	2

MAMK2520 type

		Nominal inductance	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω](max.)	Rated current ※) [mA](max.)		Measuring
Parts number EH	EHS	[μ H]				Saturation current Idc1	Temperature rise current Idc2	frequency[MHz]
MAMK2520TR47M	RoHS	0.47	±20%	-	0.039	4,200	3,400	2
MAMK2520T1R0M	RoHS	1.0	±20%	-	0.059	3,100	2,700	2
MAMK2520T2R2M	RoHS	2.2	±20%	-	0.117	2,000	1,900	2
MAMK2520T3R3M	RoHS	3.3	±20%	-	0.156	1,800	1,700	2
MAMK2520T4R7M	RoHS	4.7	±20%	-	0.260	1,500	1,300	2

- $\frak{\%}$) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)
- X) The temperature rise current value (Idc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
- XX) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

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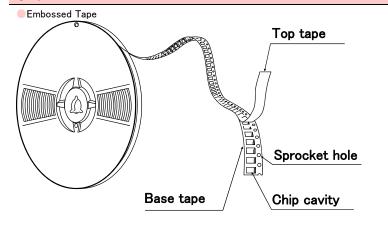
METAL CORE WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES)

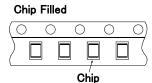
PACKAGING

1 Minimum Quantity

	Type	Standard Quantity [pcs]
	туре	Tape & Reel
	MAKK2016	3000
	MAKK2520	3000
	MAMK2520	3000

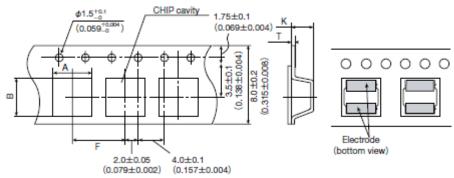
②Tape Material





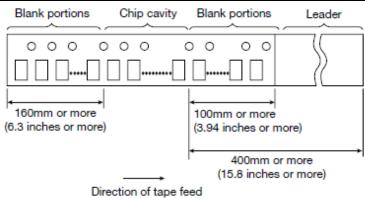
3Taping dimensions

Embossed tape 8mm wide (0.315 inches wide)



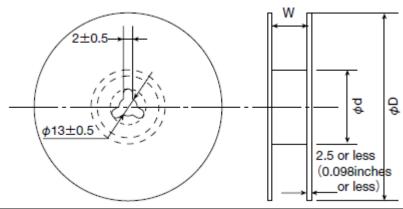
Туре	Chip	cavity	Insertion pitch	Tape thickness		
туре	Α	В	F	T	K	
MAKKOO16	1.9±0.1	2.3±0.1	4.0±0.1	0.25±0.05	1.1 max	
MAKK2016	(0.075 ± 0.004)	(0.091 ± 0.004)	(0.157 ± 0.004)	(0.009 ± 0.002)	(0.043 max)	
MAKK2520	2.3±0.1	2.8±0.1	4.0±0.1	0.3±0.05	1.1 max	
	(0.091 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.043 max)	
MANAZOTOO	2.3±0.1	2.8±0.1	4.0±0.1	0.3±0.05	1.45 max	
MAMK2520	(0.091 ± 0.004)	(0.110 ± 0.004)	(0.157 ± 0.004)	(0.012 ± 0.002)	(0.057 max)	
					Unit:mm(inch)	

4 Leader and Blank portion



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⑤Reel size

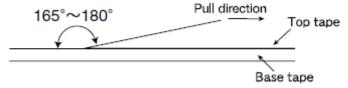


Type	Reel size (Reference values)				
туре	φD	ϕ d	W		
MAKK2016	180+0/-3	60+1/-0	10.0±1.5		
MAKK2520	(7.087+0/-0.118)	(2.36+0.039/0)	(0.394 ± 0.059)		
MAMK2520	(7.067+0/-0.116)	(2.30+0.039/0)	(0.394±0.059)		

Unit:mm(inch)

6Top Tape Strength

The top The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



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METAL CORE WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES)

RELIABILITY DATA 1. Operating Temperature Range MAKK2016 Specified Value MAKK2520 $-40 \sim +105$ °C MAMK2520 Test Methods and Including self-generated heat Remarks 2. Storage Temperature Range MAKK2016 MAKK2520 -40~+85°C Specified Value MAMK2520 Test Methods and 0 to 40°C for the product with taping. Remarks 3. Rated current MAKK2016 Specified Value MAKK2520 Within the specified tolerance MAMK2520 4. Inductance MAKK2016 Specified Value MAKK2520 Within the specified tolerance MAMK2520 Test Methods and : LCR Meter (HP 4285A or equivalent) Measuring equipment Remarks Measuring frequency : 2MHz, 1V 5. DC Resistance MAKK2016 MAKK2520 Specified Value Within the specified tolerance MAMK2520 Test Methods and : DC ohmmeter (HIOKI 3227 or equivalent) Measuring equipment Remarks 6. Self resonance frequency MAKK2016 MAKK2520 Specified Value MAMK2520 7. Temperature characteristic MAKK2016 Specified Value MAKK2520 Inductance change: Within ±15% MAMK2520

Measurement of inductance shall be taken at temperature range within $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$.

With reference to inductance value at $\pm 20^{\circ}$ C., change rate shall be calculated.

Test Methods and

Remarks

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8. Resistance to fle	xure of substrate		
	MAKK2016		
Specified Value	MAKK2520	No damage	
	MAMK2520		
Test Methods and Remarks	The test samples shall be soldered to the until deflection of the test board reacher. Test board size : 100 × 40 Test board material : glass eposolder cream thickness : 0.12 mm	× 1.0 mm Force Rod 10 20	
		R5 Test Sample 45±2mm	
0.7 1.1			
9. Insulation resista			
	MAKK2016		
Specified Value	MAKK2520		
	MAMK2520		
10. Insulation resist	ance : between wire and core		
	MAKK2016	DC25V 100kΩmin	
Specified Value	MAMK2520		
	MAKK2520	DC20V 100k Ω min	
11. Withstanding vo	tage : between wire and core		
	MAKK2016		
Specified Value	MAKK2520		
	MAMK2520		
12. Adhesion of terr	ninal electrode		
	MAKK2016	No abnormality.	
Specified Value	MAKK2520		
	MAMK2520		
	The test samples shall be soldered to the		
Test Methods and Remarks	Applied force : 10N to X Duration : 5s.	and Y directions.	
Remarks	Solder cream thickness : 0.12mm.		
13. Resistance to vi	bration		
	MAKK2016		
Specified Value	MAKK2520	Inductance change: Within ±10%	
	MAMK2520	No significant abnormality in appearance.	
The test samples shall be soldered to the test board by the reflow.			
	Then it shall be submitted to below test	conditions.	
	Frequency Range 10~55Hz		
		y not exceed acceleration 196m/s²)	
Test Methods and		Hz to 10Hz for 1min.	
Remarks	X Y Z	For 2 hours on ach X, Y, and Z axis.	
	Recovery : At least 2hrs of recovery	under the standard condition after the test, followed by the measurement within 48hrs.	

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Specified Value	MAKK2016		At least 90% of surface of terminal electrode is covered by new solder.
	MAKK2520		
	MAMK2520		
	The test samples shall be dipped in flux, and Flux: Methanol solution containing rosin 25%.		then immersed in molten solder as shown in below table.
Test Methods and Remarks	Solder Temperature	245±5°C	
Remarks	Time	5±0.5 sec.	
	XImmersion depth : All sign	des of mounting te	rminal shall be immersed.

15. Resistance to se	oldering heat			
Specified Value	MAKK2016	Inductance change : Within ±10% No significant abnormality in appearance.		
	MAKK2520			
	MAMK2520			
	The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at $260+0/-5$ °C for 5 seconds, 3 times.			
Test Methods and	Test board material : glass epoxy-resin	substrate		
Remarks	Test board thickness : 1.0mm			
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.			

16. Thermal shock					
	MAKK2016 Specified Value MAKK2520			Inductance change : Within ±10% No significant abnormality in appearance.	
Specified Value					
	MAMK2520		140 Significant abnorn		
	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified				
	time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.				
		Conditions of 1	cycle		
	Step	Temperature (°C)	Duration (min)		
Test Methods and	1 -40±3		30±3		
Remarks	2	Room temperature	Within 3		

 2
 Room temperature
 Within 3

 3
 +85±2
 30±3

 4
 Room temperature
 Within 3

Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.

17. Damp heat				
	MAKK2016			
Specified Value	MAKK2520		Inductance change : Within ±10% No significant abnormality in appearance.	
	MAMK2520		no significant autoritiality in appearance.	
	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.			
Test Methods and Remarks	Temperature	60±2°C		
Remarks	Humidity	90∼95%RH		
	Time	500+24/-0 hour		
Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within			e standard condition after the test, followed by the measurement within 48hrs.	

Specified Value	MAKK2016 MAKK2520		
			Inductance change : Within ±10% No significant abnormality in appearance.
	MAMK2520		100 Significant abnormancy in appearance.
T . M .:	The test samples shall be soldered to the to The test samples shall be placed in ther continuously as shown in below table.		rmostatic oven set at specified temperature and humidity and applied the rated curren
Test Methods and Remarks	Temperature	60±2°C	
Remarks	Humidity	90∼95%RH	
	Applied current	Rated current	
	Time	500+24/-0 hour	

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19. Low temperatur	e life test		
	MAKK2016		
Specified Value	MAKK2520		Inductance change : Within ±10% No significant abnormality in appearance.
	MAMK2520		- No significant abnormality in appearance.
	The test samples shall be soldered to the test		t board by the reflow. After that, the test samples shall be placed at test conditions as shown
Test Methods and	in below table.		_
Remarks	Temperature	-40±2°C	
	Time	500+24/-0 hour	
	Recovery : At least 2	hrs of recovery under t	he standard condition after the test, followed by the measurement within 48hrs.
20. High temperatur	re life test		
	MAKK2016		
Specified Value	MAKK2520		Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
	MAMK2520		
	The test samples sha	II be soldered to the tes	t board by the reflow. After that, the test samples shall be placed at test conditions as shown
Test Methods and	in below table.		_
Remarks	Temperature	85±2°C	
	Time	500+24/-0 hour	
	Recovery : At least 2	hrs of recovery under t	he standard condition after the test, followed by the measurement within 48hrs.
21. Loading at high	temperature life test		
	MAKK2016		
Specified Value	MAKK2520		_
	MAMK2520		
22. Standard condit	ion		
	MAKK 2016		Standard test condition :
Specified Value	MAKK 2520		Unless otherwise specified, temperature is 20±15°C and 65±20% of relative humidity. When there is any question concerning measurement result: In order to provide correlation
Specified Value	MAKK 2520		data, the test shall be condition of $20\pm2^{\circ}$ C of temperature, $65\pm5\%$ relative humidity.

Inductance is in accordance with our measured value.

MAMK 2520

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METAL CORE WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES)

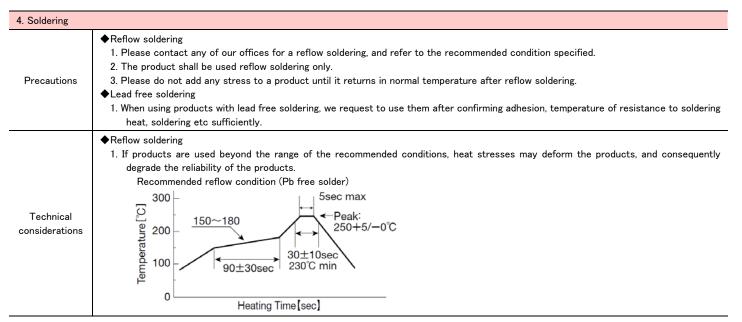
damage. For such uses, contact TAIYO YUDEN Sales Department in advance.

■PRECAUTIONS

1. Circuit Design ◆ Operating environment 1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or

2. PCB Design	
Precautions	◆Land pattern design 1. Please refer to a recommended land pattern.
Technical considerations	 ◆Land pattern design Surface Mounting • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to this products is reflow soldering only.

3. Considerations	for automatic placement
Precautions	 ◆Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.
Technical considerations	◆Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.





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6. Handling ◆Handling 1. Keep the product away from all magnets and magnetic objects. ◆Breakaway PC boards (splitting along perforations) 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆Mechanical considerations Precautions 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆Packing 1. Please avoid accumulation of a packing box as much as possible. 1. There is a case that a characteristic varies with magnetic influence. ◆Breakaway PC boards (splitting along perforations) 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆Mechanical considerations Technical 1. There is a case to be damaged by a mechanical shock. considerations 2. There is a case to be broken by the handling in transportation. ◆Pick-up pressure 1. Damage and a characteristic can vary with an excessive shock or stress. **♦**Packing 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

7. Storage condi	tions
Precautions	 ♦ Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature : 0~40°C Humidity : Below 70% RH • The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.